

# DS90CR561/DS90CR562 LVDS 18-Bit Color Flat Panel Display (FPD) Link

## General Description

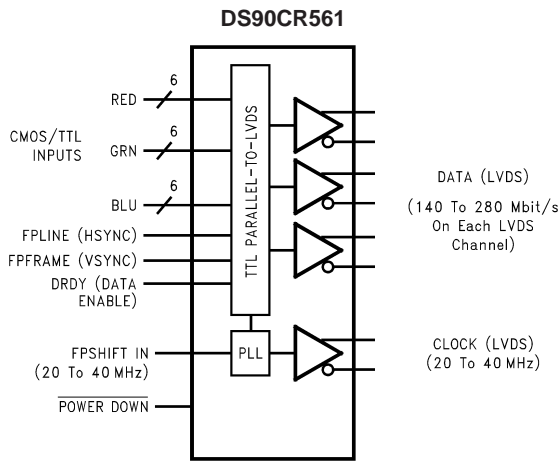
The DS90CR561 transmitter converts 21 bits of CMOS/TTL data into three LVDS (Low Voltage Differential Signaling) data streams. A phase-locked transmit clock is transmitted in parallel with the data streams over a fourth LVDS link. Every cycle of the transmit clock 21 bits of input data are sampled and transmitted. The DS90CR562 receiver converts the LVDS data streams back into 21 bits of CMOS/TTL data. At a transmit clock frequency of 40 MHz, 18 bits of RGB data and 3 bits of LCD timing and control data (FPLINE, FPFRAME, DRDY) are transmitted at a rate of 280 Mbit/s per LVDS data channel. Using a 40 MHz clock, the data throughput is 105 Megabytes per second. These devices are offered with rising edge data strobes for convenient interface with a variety of graphics and LCD panel controllers.

This chipset is an ideal means to solve EMI and cable size problems associated with wide, high speed TTL interfaces.

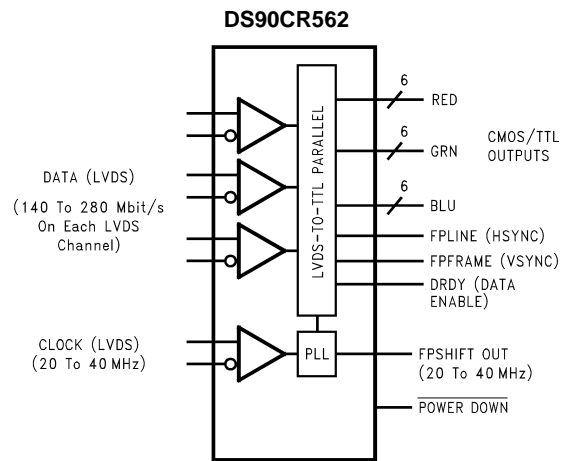
## Features

- Up to 105 Megabyte/sec bandwidth
- Narrow bus reduces cable size and cost
- 290 mV swing LVDS devices for low EMI
- Low power CMOS design
- Power-down mode
- PLL requires no external components
- Low profile 48-lead TSSOP package
- Rising edge data strobe
- Compatible with TIA/EIA-644 LVDS standard

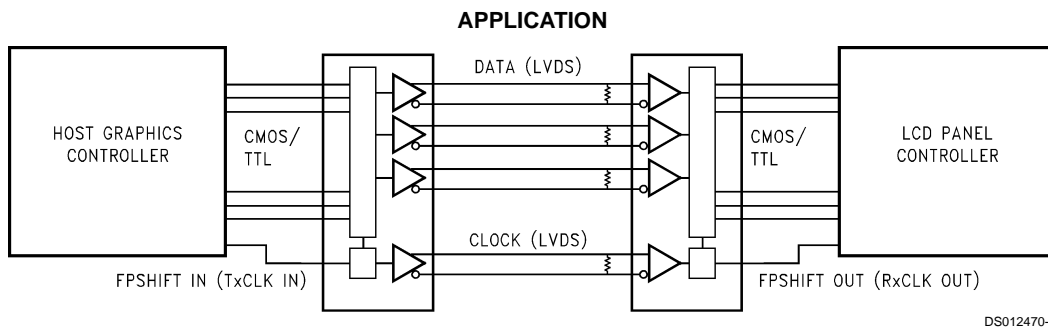
## Block Diagrams



**Order Number DS90CR561MTD**  
See NS Package Number MTD48

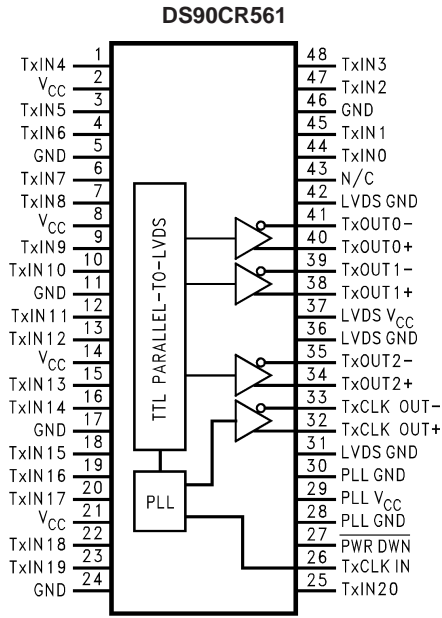


**Order Number DS90CR562MTD**  
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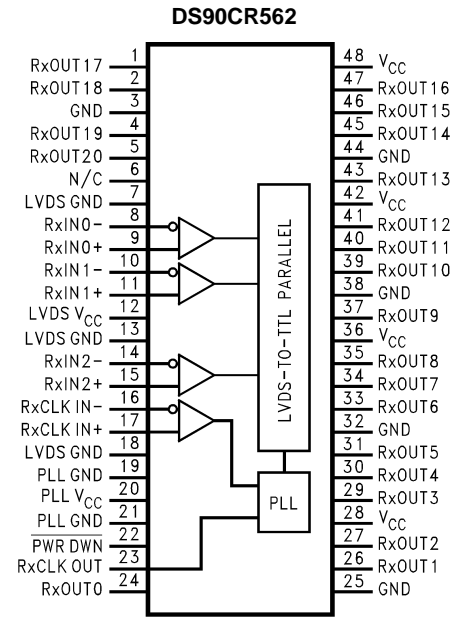


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## Connection Diagrams



DS012470-3



DS012470-4

**Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage ( $V_{CC}$ )	-0.3V to +6V
CMOS/TTL Input Voltage	-0.3V to ( $V_{CC} + 0.3V$ )
CMOS/TTL Output Voltage	-0.3V to ( $V_{CC} + 0.3V$ )
LVDS Receiver Input Voltage	-0.3V to ( $V_{CC} + 0.3V$ )
LVDS Receiver Input Voltage	-0.3V to ( $V_{CC} + 0.3V$ )
LVDS Output Short Circuit Duration	continuous
Junction Temperature	+150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (Soldering, 4 sec.)	+260°C

Maximum Power Dissipation @ +25°C

MTD48 (TSSOP) Package:

DS90CR561	1.98W
DS90CR562	1.89W

Package Derating:

DS90CR561	16 mW/°C above +25°C
DS90CR562	15 mW/°C above +25°C

This device does not meet 2000V ESD rating (Note 4)

**Recommended Operating Conditions**

	Min	Nom	Max	Units
Supply Voltage ( $V_{CC}$ )	4.5	5.0	5.5	V
Operating Free Air Temperature ( $T_A$ )	-10	+25	+70	°C
Receiver Input Range	0		2.4	V
Supply Noise Voltage ( $V_{CC}$ )			100	mV <sub>P-P</sub>

**Electrical Characteristics**

Over recommended operating supply and temperature ranges unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>CMOS/TTL DC SPECIFICATIONS</b>						
$V_{IH}$	High Level Input Voltage		2.0		$V_{CC}$	V
$V_{IL}$	Low Level Input Voltage		GND		0.8	V
$V_{OH}$	High Level Output Voltage	$I_{OH} = -0.4$ mA	3.8	4.9		V
$V_{OL}$	Low Level Output Voltage	$I_{OL} = 2$ mA		0.1	0.3	V
$V_{CL}$	Input Clamp Voltage	$I_{CL} = -18$ mA		-0.79	-1.5	V
$I_{IN}$	Input Current	$V_{IN} = V_{CC}, GND, 2.5V$ or 0.4V		±5.1	±10	µA
$I_{OS}$	Output Short Circuit Current	$V_{OUT} = 0V$			-120	mA
<b>LVDS DRIVER DC SPECIFICATIONS</b>						
$V_{OD}$	Differential Output Voltage	$R_L = 100\Omega$	250	290	450	mV
$\Delta V_{OD}$	Change in $V_{OD}$ between Complimentary Output States				35	mV
$V_{CM}$	Common Mode Voltage		1.1	1.25	1.375	V
$\Delta V_{CM}$	Change in $V_{CM}$ between Complimentary Output States				35	mV
$V_{OH}$	High Level Output Voltage			1.3	1.6	V
$V_{OL}$	Low Level Output Voltage		0.9	1.01		V
$I_{OS}$	Output Short Circuit Current	$V_{OUT} = 0V, R_L = 100\Omega$		-2.9	-5	mA
$I_{OZ}$	Output TRI-STATE® Current	Power Down = 0V, $V_{OUT} = 0V$ or $V_{CC}$		±1	±10	µA
<b>LVDS RECEIVER DC SPECIFICATIONS</b>						
$V_{TH}$	Differential Input High Threshold	$V_{CM} = +1.2V$			+100	mV
$V_{TL}$	Differential Input Low Threshold		-100			mV
$I_{IN}$	Input Current	$V_{IN} = +2.4V$	$V_{CC} = 5.5V$		±10	µA
		$V_{IN} = 0V$			±10	µA
<b>TRANSMITTER SUPPLY CURRENT</b>						
$I_{CCTW}$	Transmitter Supply Current, Worst Case	$R_L = 100\Omega, C_L = 5$ pF, Worst Case Pattern (Figures 1, 3)	$f = 32.5$ MHz	34	51	mA
			$f = 37.5$ MHz	36	53	mA
$I_{CCTG}$	Transmitter Supply Current, 16 Grayscale	$R_L = 100\Omega, C_L = 5$ pF, Grayscale Pattern (Figures 2, 3)	$f = 32.5$ MHz	27	47	mA
			$f = 37.5$ MHz	28	48	mA

## Electrical Characteristics (Continued)

Over recommended operating supply and temperature ranges unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Units	
<b>TRANSMITTER SUPPLY CURRENT</b>							
$I_{CCTZ}$	Transmitter Supply Current, Power Down	Power Down = Low		1	25	$\mu\text{A}$	
<b>RECEIVER SUPPLY CURRENT</b>							
$I_{CCRW}$	Receiver Supply Current, Worst Case	$C_L = 8 \text{ pF}$ , Worst Case Pattern (Figures 1, 4)	$f = 32.5 \text{ MHz}$		55	75	$\text{mA}$
			$f = 37.5 \text{ MHz}$		60	80	$\text{mA}$
$I_{CCRG}$	Receiver Supply Current, 16 Grayscale	$C_L = 8 \text{ pF}$ , 16 Grayscale Pattern (Figures 2, 4)	$f = 32.5 \text{ MHz}$		35	55	$\text{mA}$
			$f = 37.5 \text{ MHz}$		37	58	$\text{mA}$
$I_{CCRZ}$	Receiver Supply Current, Power Down	Power Down = Low		1	10	$\mu\text{A}$	

**Note 1:** "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The tables of "Electrical Characteristics" specify conditions for device operation.

**Note 2:** Typical values are given for  $V_{CC} = 5.0\text{V}$  and  $T_A = +25^\circ\text{C}$ .

**Note 3:** Current into device pins is defined as positive. Current out of device pins is defined as negative. Voltages are referenced to ground unless otherwise specified (except  $V_{OD}$  and  $\Delta V_{OD}$ ).

**Note 4:** ESD Rating: HBM (1.5 k $\Omega$ , 100 pF)

PLL  $V_{CC} \geq 1000\text{V}$

All other pins  $\geq 2000\text{V}$

EIAJ (0 $\Omega$ , 200 pF)  $\geq 150\text{V}$

## Transmitter Switching Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified

Symbol	Parameter	Min	Typ	Max	Units	
LLHT	LVDS Low-to-High Transition Time (Figure 3)		0.75	1.5	ns	
LHLT	LVDS High-to-Low Transition Time (Figure 3)		0.75	1.5	ns	
TCIT	TxCLK IN Transition Time (Figure 5)			8	ns	
TCCS	TxOUT Channel-to-Channel Skew (Note 5) (Figure 6)			350	ps	
TPPos0	Transmitter Output Pulse Position for Bit 0 (Figure 17)	$f = 20 \text{ MHz}$	-200	150	350	ps
TPPos1	Transmitter Output Pulse Position for Bit 1		6.3	7.2	7.5	ns
TPPos2	Transmitter Output Pulse Position for Bit 2		12.8	13.6	14.6	ns
TPPos3	Transmitter Output Pulse Position for Bit 3		20	20.8	21.5	ns
TPPos4	Transmitter Output Pulse Position for Bit 4		27.2	28	28.5	ns
TPPos5	Transmitter Output Pulse Position for Bit 5		34.5	35.2	35.6	ns
TPPos6	Transmitter Output Pulse Position for Bit 6		42.2	42.6	42.9	ns
TPPos0	Transmitter Output Pulse Position for Bit 0 (Figure 17)	$f = 40 \text{ MHz}$	-100	100	300	ps
TPPos1	Transmitter Output Pulse Position for Bit 1		2.9	3.3	3.9	ns
TPPos2	Transmitter Output Pulse Position for Bit 2		6.1	6.6	7.1	ns
TPPos3	Transmitter Output Pulse Position for Bit 3		9.7	10.2	10.7	ns
TPPos4	Transmitter Output Pulse Position for Bit 4		13	13.5	14.1	ns
TPPos5	Transmitter Output Pulse Position for Bit 5		17	17.4	17.8	ns
TPPos6	Transmitter Output Pulse Position for Bit 6		20.3	20.8	21.4	ns
TCIP	TxCLK IN Period (Figure 7)	25	T	50	ns	
TCIH	TxCLK IN High Time (Figure 7)	0.35T	0.5T	0.65T	ns	
TCIL	TxCLK IN Low Time (Figure 7)	0.35T	0.5T	0.65T	ns	
TSTC	TxIN Setup to TxCLK IN (Figure 7)	$f = 20 \text{ MHz}$	14			ns
		$f = 40 \text{ MHz}$	8			ns
THTC	TxIN Hold to TxCLK IN (Figure 7)	2.5	2		ns	
TCCD	TxCLK IN to TxCLK OUT Delay @ $25^\circ\text{C}$ , $V_{CC} = 5.0\text{V}$ (Figure 9)	5		9.7	ns	
TPLLS	Transmitter Phase Lock Loop Set (Figure 11)			10	ms	

## Transmitter Switching Characteristics (Continued)

Over recommended operating supply and temperature ranges unless otherwise specified

Symbol	Parameter	Min	Typ	Max	Units
TPDD	Transmitter Powerdown Delay (Figure 15)			100	ns

**Note 5:** This limit based on bench characterization.

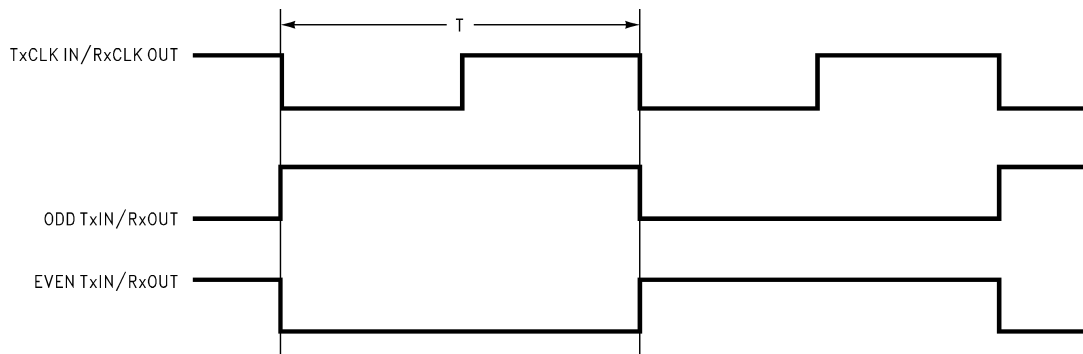
## Receiver Switching Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified

Symbol	Parameter	Min	Typ	Max	Units
CLHT	CMOS/TTL Low-to-High Transition Time (Figure 4)		3.5	6.5	ns
CHLT	CMOS/TTL High-to-Low Transition Time (Figure 4)		2.7	6.5	ns
RCOP	RxCLK OUT Period (Figure 8)	25	T	50	ns
RSKM	Receiver Skew Margin (Note 6) $V_{CC} = 5V, T_A = 25^\circ C$ (Figure 18)	f = 20 MHz	1.1		ns
		f = 40 MHz	700		ps
RCOH	RxCLK OUT High Time (Figure 8)	f = 20 MHz	19		ns
		f = 40 MHz	6		ns
RCOL	RxCLK OUT Low Time (Figure 8)	f = 20 MHz	21.5		ns
		f = 40 MHz	10.5		ns
RSRC	RxCLK Setup to RxCLK OUT (Figure 8)	f = 20 MHz	14		ns
		f = 40 MHz	4.5		ns
RHRC	RxCLK Hold to RxCLK OUT (Figure 8)	f = 20 MHz	16		ns
		f = 40 MHz	6		ns
RCCD	RxCLK IN to RxCLK OUT Delay @ 25°C, $V_{CC} = 5.0V$ (Figure 10)	7.6		11.9	ns
RPLLS	Receiver Phase Lock Loop Set (Figure 12)			10	ms
RPDD	Receiver Powerdown Delay (Figure 16)			1	μs

**Note 6:** Receiver Skew Margin is defined as the valid data sampling region at the receiver inputs. This margin takes into account for transmitter output skew (TCCS) and the setup and hold time (internal data sampling window), allowing LVDS cable skew dependant on the type/length and source clock (TxCLK IN) jitter.  
 $RSKM \geq \text{cable skew (type, length)} + \text{source clock jitter (cycle to cycle)}$ .

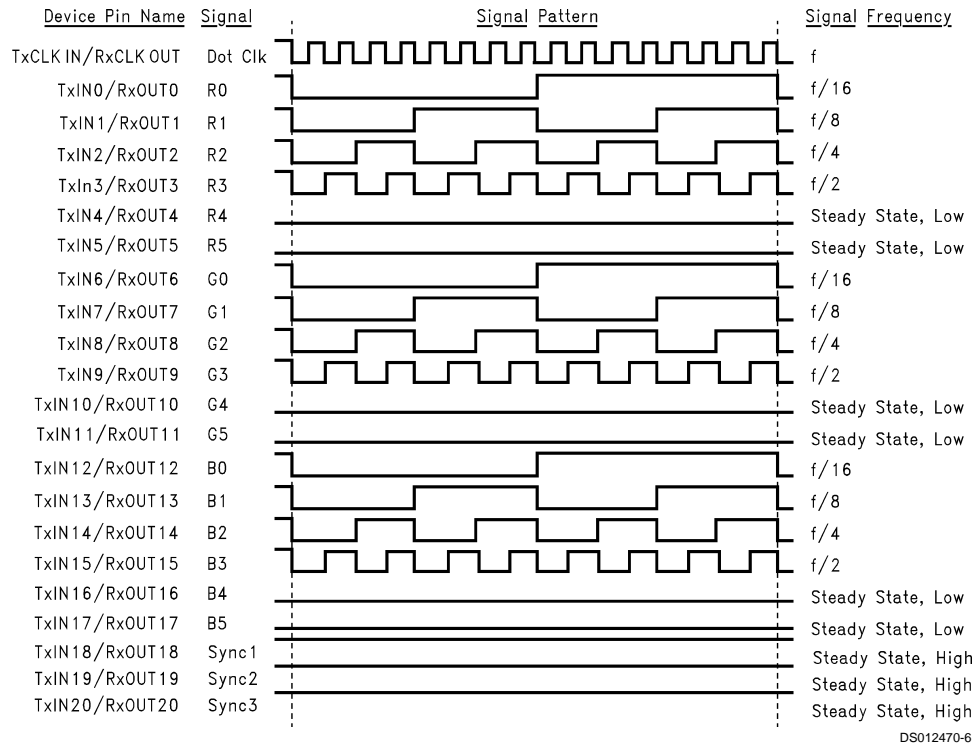
## AC Timing Diagrams



DS012470-5

FIGURE 1. "Worst Case" Test Pattern

## AC Timing Diagrams (Continued)



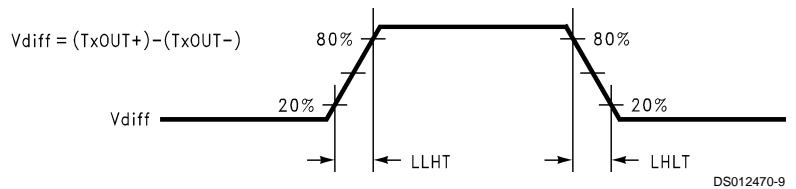
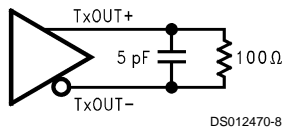
**Note 7:** The worst case test pattern produces a maximum toggling of device digital circuitry, LVDS I/O and TTL I/O.

**Note 8:** The 16 grayscale test pattern tests device power consumption for a "typical" LCD display pattern. The test pattern approximates signal switching needed to produce groups of 16 vertical stripes across the display.

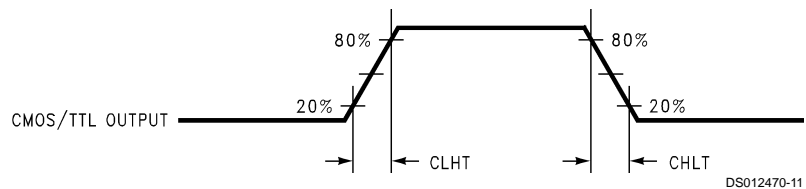
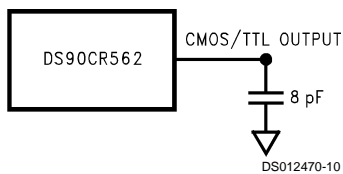
**Note 9:** Figure 1 and Figure 2 show a rising edge data strobe (TxCLK IN/RxCLK OUT).

**Note 10:** Recommended pin to signal mapping. Customer may choose to define differently.

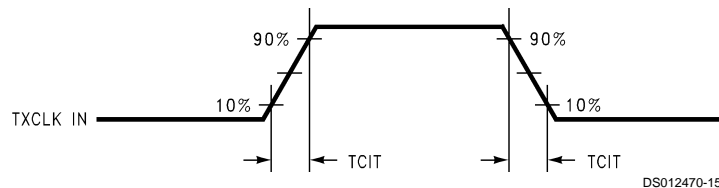
**FIGURE 2. "16 Grayscale" Test Pattern (Notes 7, 8, 9, 10)**



**FIGURE 3. DS90CR561 (Transmitter) LVDS Output Load and Transition Timing**

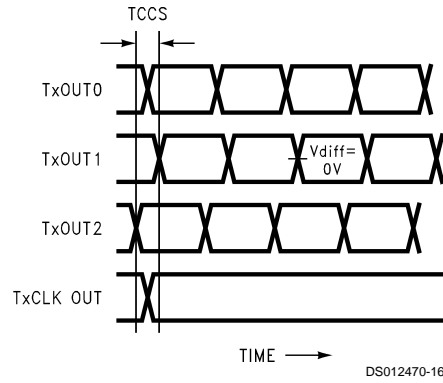


**FIGURE 4. DS90CR562 (Receiver) CMOS/TTL Output Load and Transition Timing**



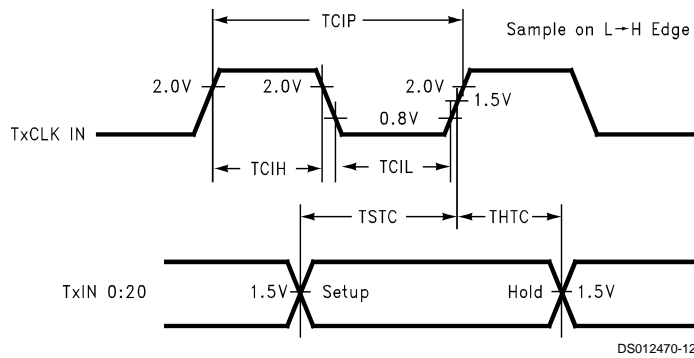
**FIGURE 5. DS90CR561 (Transmitter) Input Clock Transition Time**

# AC Timing Diagrams (Continued)

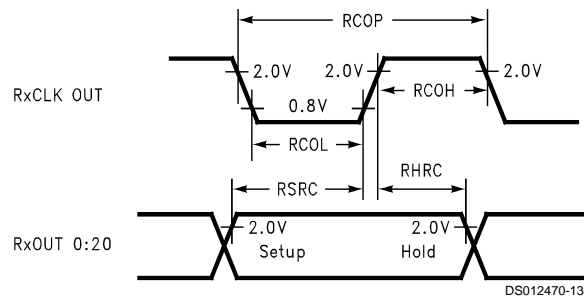


Measurements at  $V_{diff} = 0V$   
 TCCS measured between earliest and latest initial LVDS edges.  
 TxCLK OUT Differential High→Low Edge for DS90CF561  
 TxCLK OUT Differential Low→High Edge for DS90CR561

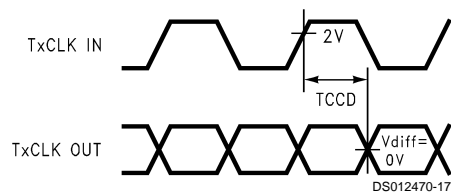
**FIGURE 6. DS90CR561 (Transmitter) Channel-to-Channel Skew and Pulse Width**



**FIGURE 7. DS90CR561 Setup/Hold and High/Low Times**



**FIGURE 8. DS90CR562 Setup/Hold and High/Low Times**



**FIGURE 9. DS90CR561 (Transmitter) Clock In to Clock Out Delay**

AC Timing Diagrams (Continued)

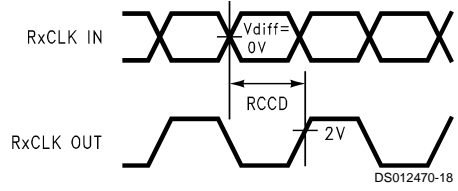


FIGURE 10. DS90CR562 (Receiver) Clock In to Clock Out Delay

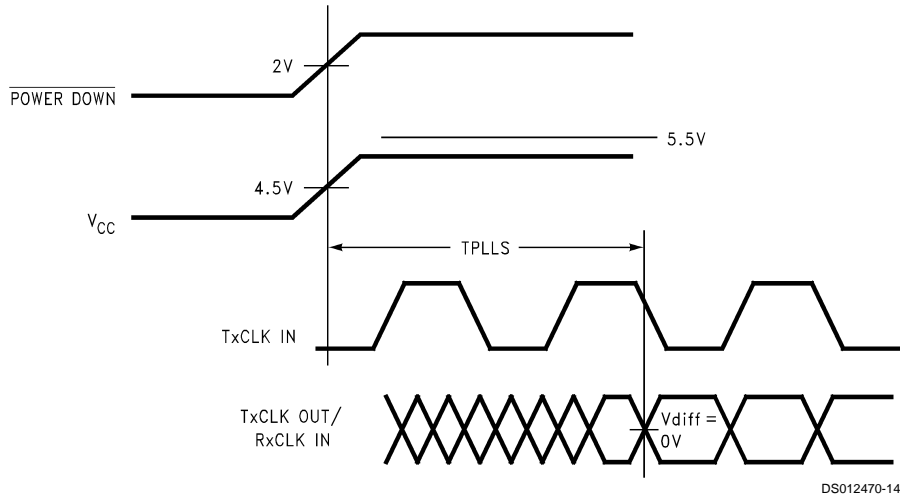


FIGURE 11. DS90CR561 (Transmitter) Phase Lock Loop Set Time

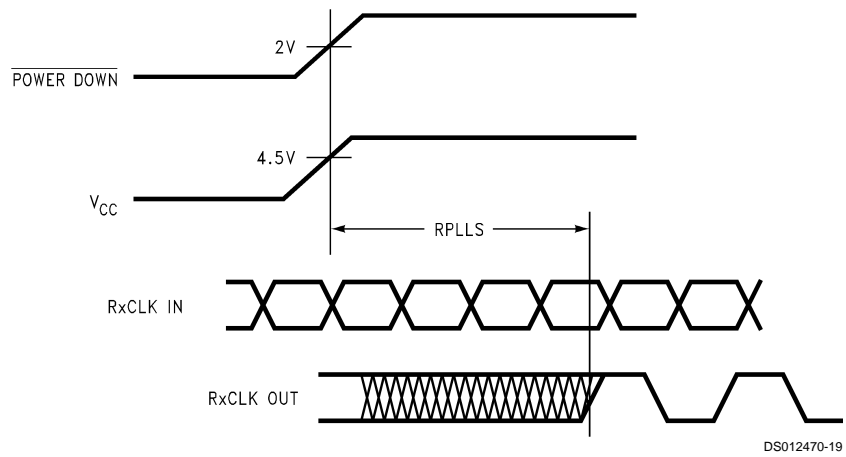


FIGURE 12. DS90CR562 (Receiver) Phase Lock Loop Set Time

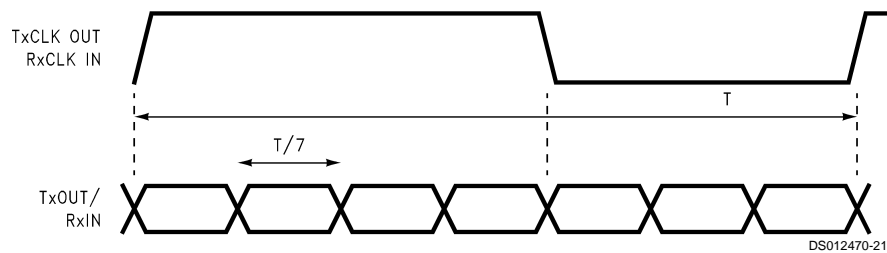


FIGURE 13. Seven Bits of LVDS in One Clock Cycle



AC Timing Diagrams (Continued)

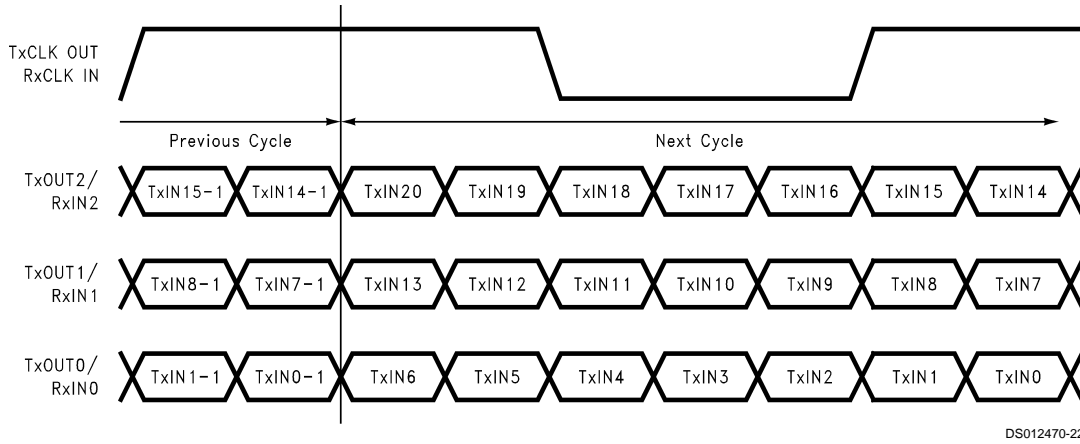


FIGURE 14. 21 Parallel TTL Data Inputs Mapped to LVDS Outputs (DS90CR561)

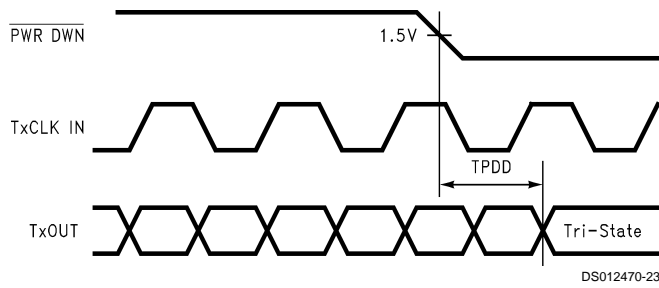


FIGURE 15. Transmitter Powerdown Delay

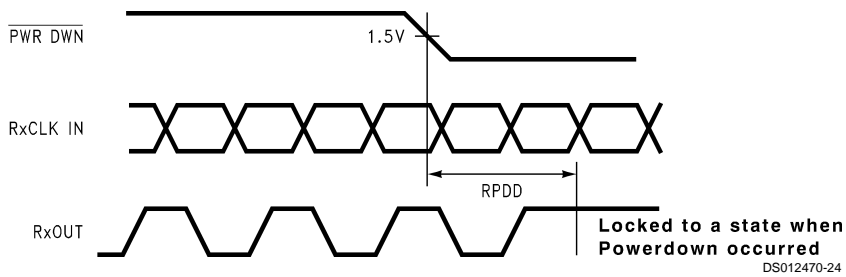
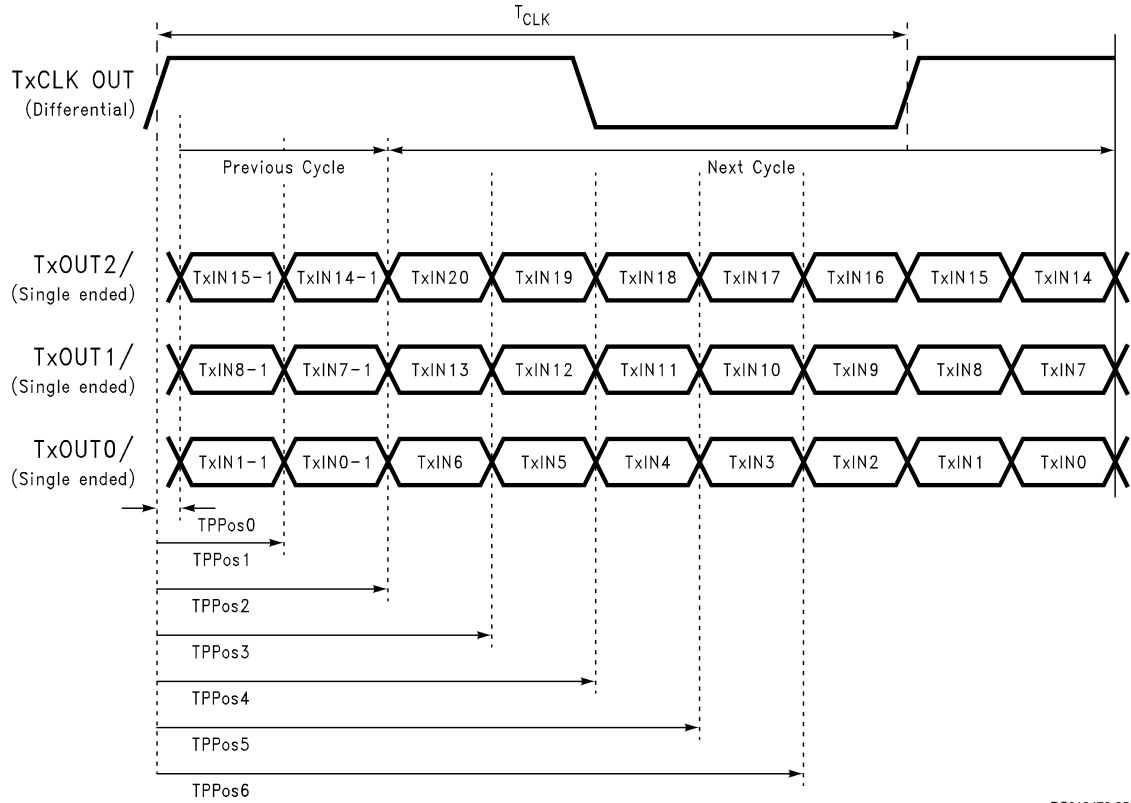


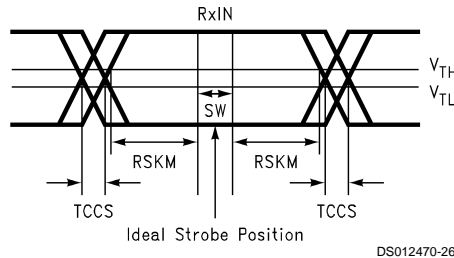
FIGURE 16. Receiver Powerdown Delay

AC Timing Diagrams (Continued)



DS012470-25

FIGURE 17. Transmitter LVDS Output Pulse Position Measurement



DS012470-26

SW—Setup and Hold Time (Internal data sampling window)  
 TCCS—Transmitter Output Skew  
 $RSKM \geq \text{Cable Skew (type, length)} + \text{Source Clock Jitter (cycle to cycle)}$   
 Cable Skew—Typically 10 ps–40 ps per foot

FIGURE 18. Receiver LVDS Input Skew Margin

DS90CR561 Pin Description—FPD Link Transmitter

Pin Name	I/O	No.	Description
TxIN	I	21	TTL Level input. This includes: 6 Red, 6 Green, 6 Blue, and 3 control lines (FPLINE, FPFAME, DRDY). (Also referred to as HSYNC, VSYNC and DATA ENABLE.)
TxOUT+	O	3	Positive LVDS differential data output
TxOUT-	O	3	Negative LVDS differential data output
FPSHIFT IN	I	1	TTL level clock input. The rising edge acts as data strobe.
TxCLK OUT+	O	1	Positive LVDS differential clock output
TxCLK OUT-	O	1	Negative LVDS differential clock output
PWR DOWN	I	1	TTL level input. Assertion (low input) TRI-STATES the outputs, ensuring low current at power down.

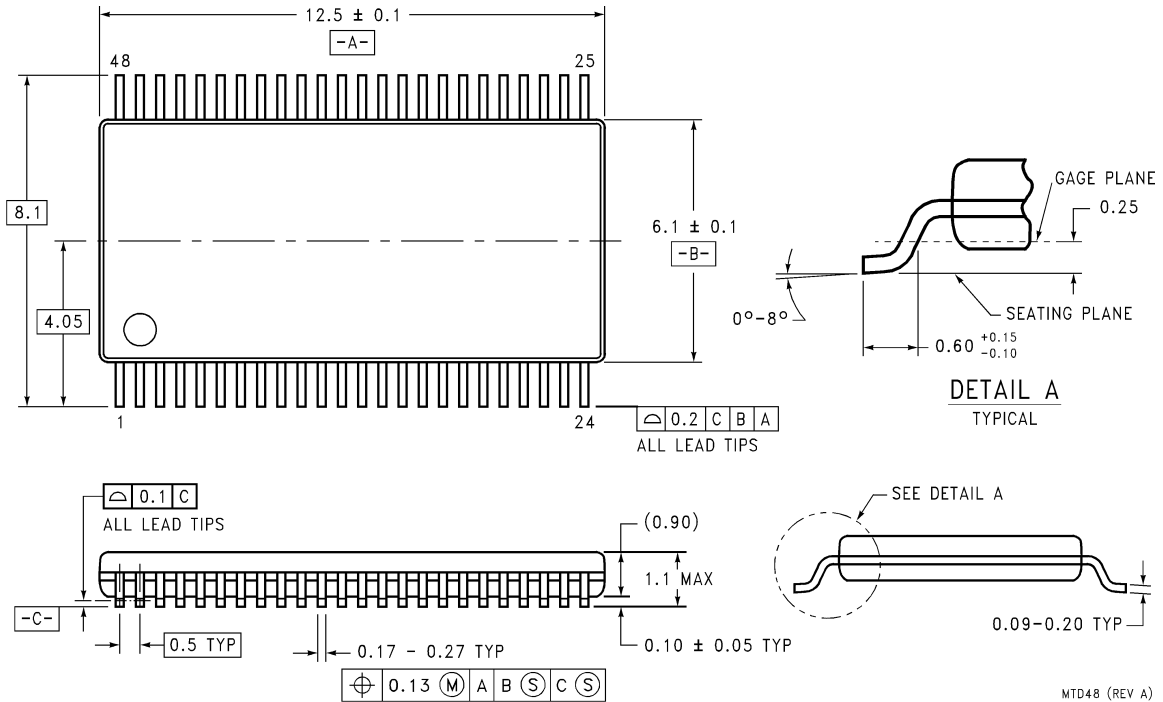
**DS90CR561 Pin Description—FPD Link Transmitter** (Continued)

Pin Name	I/O	No.	Description
V <sub>CC</sub>	I	4	Power supply pins for TTL inputs
GND	I	5	Ground pins for TTL inputs
PLL V <sub>CC</sub>	I	1	Power supply pin for PLL
PLL GND	I	2	Ground pins for PLL
LVDS V <sub>CC</sub>	I	1	Power supply pin for LVDS outputs
LVDS GND	I	3	Ground pins for LVDS outputs

**DS90CR562 Pin Description—FPD Link Receiver**

Pin Name	I/O	No.	Description
RxIN+	I	3	Positive LVDS differential data inputs
RxIN-	I	3	Negative LVDS differential data inputs
RxOUT	O	21	TTL level outputs. This includes: 6 Red, 6 Green, 6 Blue, and 3 control lines (FPLINE, FPFRAME, DRDY). (Also referred to as HSYNC, VSYNC and DATA ENABLE.)
RxCLK IN+	I	1	Positive LVDS differential clock input
RxCLK IN-	I	1	Negative LVDS differential clock input
FPSHIFT OUT	O	1	TTL level clock output. The rising edge acts as data strobe.
PWR DOWN	I	1	TTL level input. Assertion (low input) maintains the receiver outputs in the previous state.
V <sub>CC</sub>	I	4	Power supply pins for TTL outputs
GND	I	5	Ground pins for TTL outputs
PLL V <sub>CC</sub>	I	1	Power supply for PLL
PLL GND	I	2	Ground pin for PLL
LVDS V <sub>CC</sub>	I	1	Power supply pin for LVDS inputs
LVDS GND	I	3	Ground pins for LVDS inputs

**Physical Dimensions** inches (millimeters) unless otherwise noted



**48-Lead Molded Thin Shrink Small Outline Package, JEDEC  
NS Package Number MTD48**

MTD48 (REV A)

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# DS90CR561 Product Folder

## LVDS 18-Bit Color Flat Panel Display (FPD) Link

**See Also:** [DS90C363A](#) - 3V supply

[General Description](#)

[Features](#)

[Datasheet](#)

[Package & Models](#)

[Samples & Pricing](#)

[Application Notes](#)

### Parametric Table

Supply Voltage	5 V
Pixel Clock	20 - 40 MHz

### Parametric Table

Graphic Bits (bit)	6
Strobe Edge	Rising
Function	Transmitter

### Datasheet

Title	Size in Kbytes	Date	<a href="#">View Online</a>	<a href="#">Download</a>	<a href="#">Receive via Email</a>
DS90CR561 DS90CR562 LVDS 18-Bit Color Flat Panel Display (FPD) Link	242 Kbytes	16-Aug-00	<a href="#">View Online</a>	<a href="#">Download</a>	<a href="#">Receive via Email</a>
DS90CR561 DS90CR562 LVDS 18-Bit Color Flat Panel Display (FPD) Link ( <b>JAPANESE</b> )	434 Kbytes		<a href="#">View Online</a>	<a href="#">Download</a>	<a href="#">Receive via</a>

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### Package Availability, Models, Samples & Pricing

Part Number	Package			Status	Models		Samples & Electronic Orders	Budgetary Pricing		Std Pack Size	<a href="#">Package Marking</a>
	Type	Pins	MSL		SPICE	IBIS		Qty	\$US each		
DS90CR561MTD	<a href="#">TSSOP</a>	48	<a href="#">MSL</a>	Full production	N/A	N/A	<a href="#">24 Hour Buy Now</a>	1K+	\$5.9500	rail of 38	[logo]cUcZc2cT DS90CR561MTD cB
DS90CR561MTDX	<a href="#">TSSOP</a>	48	<a href="#">MSL</a>	Full production	N/A	N/A		1K+	\$5.9500	reel of 1000	[logo]cUcZc2cT DS90CR561MTD cB

DS90CR561 MDC	<a href="#">Die</a>	Full production	N/A	N/A	<a href="#">Samples</a>			tray of N/A	-
DS90CR561 MWC	<a href="#">Wafer</a>	Full production	N/A	N/A				wafer jar of N/A	-

## General Description

The DS90CR561 transmitter converts 21 bits of CMOS/TTL data into three LVDS (Low Voltage Differential Signaling) data streams. A phase-locked transmit clock is transmitted in parallel with the data streams over a fourth LVDS link. Every cycle of the transmit clock 21 bits of input data are sampled and transmitted. The DS90CR562 receiver converts the LVDS data streams back into 21 bits of CMOS/TTL data. At a transmit clock frequency of 40 MHz, 18 bits of RGB data and 3 bits of LCD timing and control data (FPLINE, FPFRAME, DRDY) are transmitted at a rate of 280 Mbps per LVDS data channel. Using a 40 MHz clock, the data throughput is 105 Megabytes per second. These devices are offered with rising edge data strobes for convenient interface with a variety of graphics and LCD panel controllers.

This chipset is an ideal means to solve EMI and cable size problems associated with wide, high speed TTL interfaces.

## Features

- Up to 105 Megabyte/sec bandwidth
- Narrow bus reduces cable size and cost
- 290 mV swing LVDS devices for low EMI
- Low power CMOS design
- Power-down mode
- PLL requires no external components
- Low profile 48-lead TSSOP package
- Rising edge data strobe
- Compatible with TIA/EIA-644 LVDS standard

## Application Notes

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<b>AN-1032:</b> Application Note 1032 An Introduction to FPD Link	80 Kbytes	5-Oct-98	<a href="#">View Online</a>	<a href="#">Download</a>	<a href="#">Receive via Email</a>
Application Note 1032 An Introduction to FPD Link (JAPANESE)	133 Kbytes		<a href="#">View Online</a>	<a href="#">Download</a>	<a href="#">Receive via</a>

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# DS90CR562 Product Folder

## LVDS 18-Bit Color Flat Panel Display (FPD) Link

**See Also:** [DS90CF364A](#) - 3V supply

[General Description](#)

[Features](#)

[Datasheet](#)

[Package & Models](#)

[Samples & Pricing](#)

### Parametric Table

Supply Voltage	5 V
Pixel Clock	20 - 40 MHz

### Parametric Table

Graphic Bits (bit)	6
Strobe Edge	Rising
Function	Receiver

### Datasheet

Title	Size in Kbytes	Date	<a href="#">View Online</a>	<a href="#">Download</a>	<a href="#">Receive via Email</a>
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DS90CR561 DS90CR562 LVDS 18-Bit Color Flat Panel Display (FPD) Link ( <b>JAPANESE</b> )	438 Kbytes		<a href="#">View Online</a>	<a href="#">Download</a>	<a href="#">Receive via</a>

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DS90CR562 MDC	<a href="#">Die</a>	Full production	N/A	N/A	Samples			tray of N/A	-
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